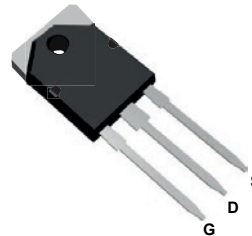
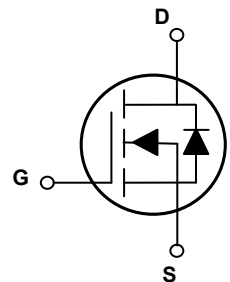


### Main Product Characteristics

|               |             |
|---------------|-------------|
| $V_{(BR)DSS}$ | 250V        |
| $R_{DS(ON)}$  | 46mΩ (Max.) |
| $I_D$         | 68A         |



TO-3P



Schematic Diagram

### Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



### Description

The GSFV2546 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

### Absolute Maximum Ratings ( $T_C=25^{\circ}\text{C}$ unless otherwise specified)

| Parameter                                                              | Symbol          | Value       | Unit                  |
|------------------------------------------------------------------------|-----------------|-------------|-----------------------|
| Drain-Source Voltage                                                   | $V_{DS}$        | 250         | V                     |
| Gate-to-Source Voltage                                                 | $V_{GS}$        | $\pm 30$    | V                     |
| Continuous Drain Current, @ Steady-State ( $T_C=25^{\circ}\text{C}$ )  | $I_D$           | 68          | A                     |
| Continuous Drain Current, @ Steady-State ( $T_C=100^{\circ}\text{C}$ ) |                 | 45.6        | A                     |
| Pulsed Drain Current <sup>1</sup>                                      | $I_{DM}$        | 272         | A                     |
| Power Dissipation ( $T_C=25^{\circ}\text{C}$ )                         | $P_D$           | 480         | W                     |
|                                                                        |                 | 3.84        | W/ $^{\circ}\text{C}$ |
| Single Pulse Avalanche Energy <sup>4</sup>                             | $E_{AS}$        | 625         | mJ                    |
| Single Pulse Avalanche Current <sup>4</sup>                            | $I_{AS}$        | 50          | A                     |
| Thermal Resistance, Junction-to-Ambient (PCB Mounted, Steady-State)    | $R_{\theta JA}$ | 62          | $^{\circ}\text{C/W}$  |
| Thermal Resistance, Junction-to-Case                                   | $R_{\theta JC}$ | 0.26        | $^{\circ}\text{C/W}$  |
| Operating Junction and Storage Temperature Range                       | $T_J/T_{STG}$   | -55 to +150 | $^{\circ}\text{C}$    |
| Maximum Lead Temperature for Soldering Purposes                        | $T_L$           | 260         | $^{\circ}\text{C}$    |

**Electrical Characteristics** ( $T_C=25^\circ\text{C}$  unless otherwise specified)

| Parameter                                       | Symbol        | Conditions                                                                              | Min. | Typ.  | Max. | Unit       |
|-------------------------------------------------|---------------|-----------------------------------------------------------------------------------------|------|-------|------|------------|
| <b>On / Off Characteristics</b>                 |               |                                                                                         |      |       |      |            |
| Drain-to-Source Breakdown Voltage               | $V_{(BR)DSS}$ | $V_{GS}=0V, I_D=250\mu A$                                                               | 250  | -     | -    | V          |
| Drain-to-Source Leakage Current                 | $I_{DSS}$     | $V_{DS}=250V, V_{GS}=0V, T_C=25^\circ\text{C}$                                          | -    | -     | 1.0  | $\mu A$    |
|                                                 |               | $V_{DS}=200V, T_C=125^\circ\text{C}$                                                    | -    | -     | 100  | $\mu A$    |
| Gate-to-Source Forward Leakage                  | $I_{GSS}$     | $V_{DS}=0V, V_{GS}=20V$                                                                 | -    | -     | 100  | nA         |
|                                                 |               | $V_{DS}=0V, V_{GS}=-20V$                                                                | -    | -     | -100 |            |
| Static Drain-to-Source On-Resistance            | $R_{DS(ON)}$  | $V_{GS}=10V, I_D=20A$                                                                   | -    | 34.5  | 46   | m $\Omega$ |
| Gate Threshold Voltage                          | $V_{GS(th)}$  | $V_{DS}=V_{GS}, I_D=250\mu A$                                                           | 3.0  | -     | 4.9  | V          |
| <b>Dynamic and Switching Characteristics</b>    |               |                                                                                         |      |       |      |            |
| Input Capacitance                               | $C_{iss}$     | $V_{GS}=0V, V_{DS}=50V, f=1\text{MHz}$                                                  | -    | 8502  | -    | pF         |
| Output Capacitance                              | $C_{oss}$     |                                                                                         | -    | 425   | -    |            |
| Reverse Transfer Capacitance                    | $C_{rss}$     |                                                                                         | -    | 86    | -    |            |
| Total Gate Charge <sup>2,3</sup>                | $Q_g$         | $I_D=40A, V_{DS}=50V, V_{GS}=10V$                                                       | -    | 152   | -    | nC         |
| Gate-to-Source Charge <sup>2,3</sup>            | $Q_{gs}$      |                                                                                         | -    | 21.8  | -    |            |
| Gate-to-Drain ("Miller") Charge <sup>2,3</sup>  | $Q_{gd}$      |                                                                                         | -    | 43.5  | -    |            |
| Turn-On Delay Time <sup>2,3</sup>               | $t_{d(on)}$   | $V_{DD}=50V, V_{GS}=10V, R_G=3\Omega, I_D=40A$                                          | -    | 35.8  | -    | nS         |
| Rise Time <sup>2,3</sup>                        | $t_r$         |                                                                                         | -    | 9.8   | -    |            |
| Turn-Off Delay Time <sup>2,3</sup>              | $t_{d(off)}$  |                                                                                         | -    | 63    | -    |            |
| Fall Time <sup>2,3</sup>                        | $t_f$         |                                                                                         | -    | 6.1   | -    |            |
| Gate Resistance                                 | $R_g$         | $V_{GS}=0V, V_{DS}=0V, f=1\text{MHz}$                                                   | -    | 1.5   | -    | $\Omega$   |
| <b>Drain-Source Ratings and Characteristics</b> |               |                                                                                         |      |       |      |            |
| Continuous Source Current (Body Diode)          | $I_S$         | $T_C=25^\circ\text{C}$ , MOSFET symbol showing the integral reverse p-n junction diode. | -    | -     | 68   | A          |
| Diode Pulse Current                             | $I_{SM}$      |                                                                                         | -    | -     | 272  | A          |
| Diode Forward Voltage                           | $V_{SD}$      | $I_S=20A, V_{GS}=0V$                                                                    | -    | -     | 1.3  | V          |
| Reverse Recovery Time                           | $t_{rr}$      | $I_S=40A, V_{GS}=0V, di_F/dt=100A/\mu s$                                                | -    | 156.7 | -    | nS         |
| Reverse Recovery Charge                         | $Q_{rr}$      |                                                                                         | -    | 1.07  | -    | $\mu C$    |

Notes:

1. Pulse width limited by maximum junction temperature.
2. Pulse test: Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.
4.  $E_{AS}$  condition:  $T_J=25^\circ\text{C}$ ,  $V_{DD}=40V$ ,  $V_G=10V$ ,  $R_g=25\Omega$ ,  $L=0.5\text{mH}$ .

## Typical Electrical and Thermal Characteristic Curves

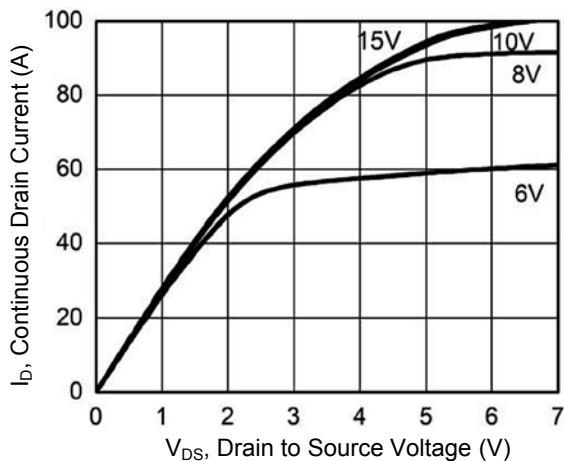


Figure 1. Output Characteristics

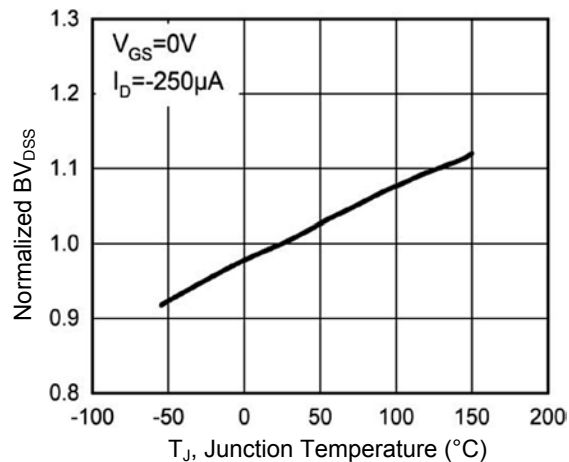


Figure 2. Normalized  $R_{DS(ON)}$  vs.  $T_J$

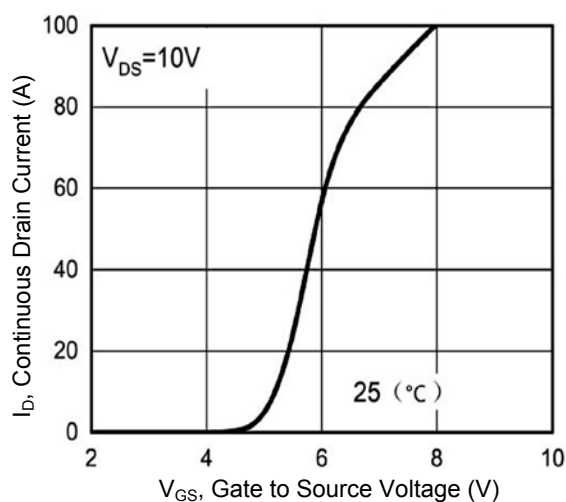


Figure 3. Transfer Characteristics

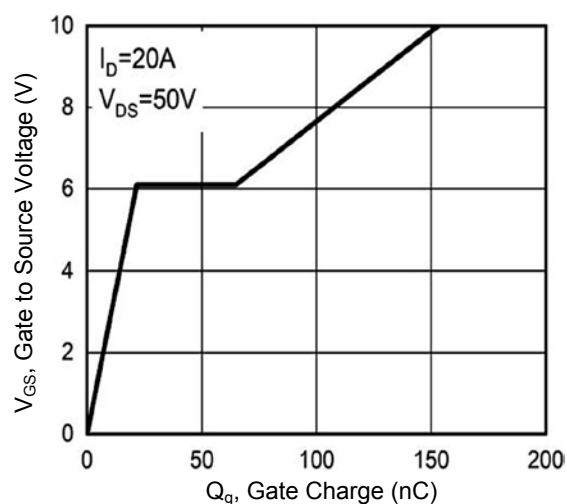


Figure 4. Gate Charge Waveform

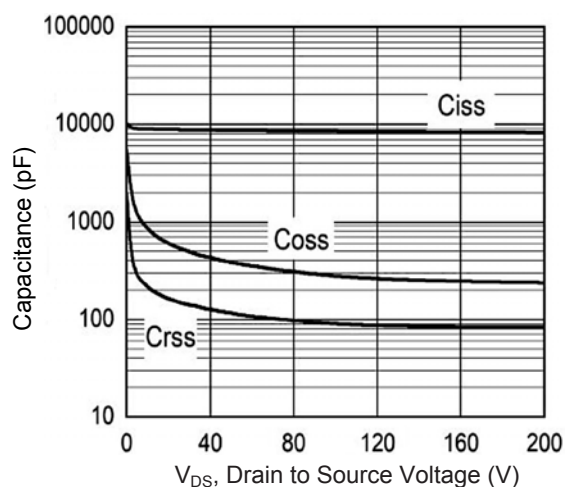


Figure 5. Capacitance Characteristics

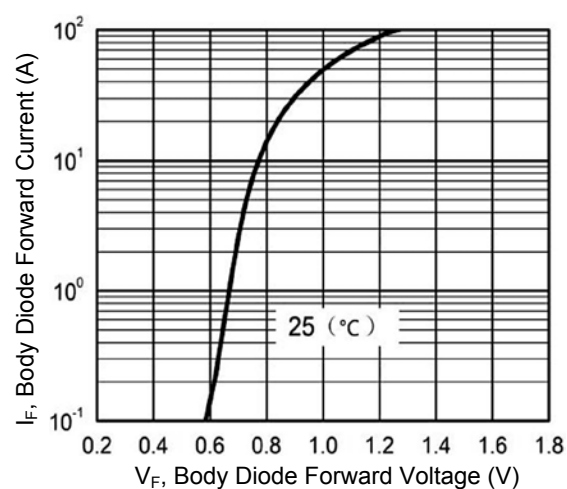
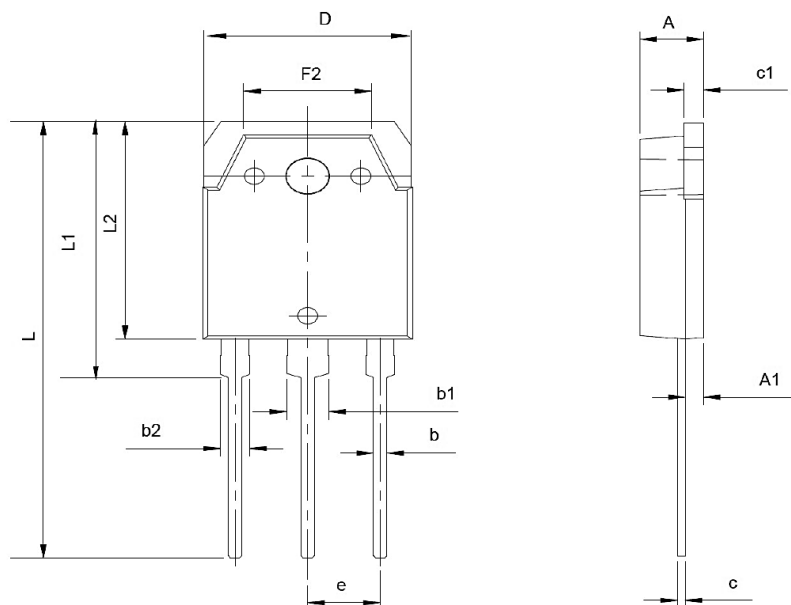


Figure 6. Body Diode Characteristics

## Package Outline Dimensions (TO-3P)



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 4.40                      | 5.20  | 0.173                | 0.205 |
| c1     | 1.20                      | 1.80  | 0.047                | 0.071 |
| A1     | 1.20                      | 2.00  | 0.047                | 0.079 |
| b      | 0.70                      | 1.30  | 0.028                | 0.051 |
| b1     | 2.70                      | 3.30  | 0.106                | 0.130 |
| b2     | 1.70                      | 2.30  | 0.067                | 0.091 |
| D      | 15.00                     | 16.00 | 0.591                | 0.630 |
| c      | 0.40                      | 0.80  | 0.016                | 0.031 |
| F2     | 8.50                      | 10.00 | 0.335                | 0.394 |
| e      | 5.45 TYP                  |       | 0.215 TYP            |       |
| L1     | 22.60                     | 23.60 | 0.890                | 0.929 |
| L      | 39.00                     | 41.50 | 1.535                | 1.634 |
| L2     | 19.50                     | 21.00 | 0.768                | 0.827 |

## Order Information

| Device   | Package | Marking | Carrier | Quantity      |
|----------|---------|---------|---------|---------------|
| GSFV2546 | TO-3P   | V2546   | Tube    | 30 Pcs / Tube |